

# SSH22N50-VB Datasheet

# N-Channel 600 V (D-S) Super Junction MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	600					
R <sub>DS(on)</sub> (Ω) at 25 °C	$V_{GS} = 10 V$	0.19				
Q <sub>g</sub> max. (nC)	106					
Q <sub>gs</sub> (nC)	14					
Q <sub>gd</sub> (nC)	33					
Configuration	Single					

## **FEATURES**

- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM)  $R_{on} \times Q_g$
- Low input capacitance (C<sub>iss</sub>)
- Low switching losses due to reduced Q<sub>rr</sub>
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)

## **APPLICATIONS**

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Consumer and computing
  - ATX power supplies
- Industrial
  - Welding
  - Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switch mode power supplies (SMPS)

то-зр	
G D S	D (TAB)
	S N-Channel MOSFET

= 25 °C, unless otherwis	se noted)			
PARAMETER			UNIT	
Drain-Source Voltage			v	
Gate-Source Voltage			v	
$T_{\rm C} = 25 ^{\circ}{\rm C}$	- I <sub>D</sub> -	20	А	
$T_{\rm C} = 100 ^{\circ}{\rm C}$		13		
Pulsed Drain Current <sup>a</sup>				
Linear Derating Factor		1.7	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			mJ	
Maximum Power Dissipation			W	
Operating Junction and Storage Temperature Range			°C	
T <sub>J</sub> = 125 °C	d\//dt	37	V/ns	
Reverse Diode dV/dt <sup>d</sup>			v/ns	
for 10 s		300	°C	
	$V_{GS}$ at 10 V $T_{C} = 25 °C$ $T_{C} = 100 °C$ $T_{J} = 125 °C$	$\begin{tabular}{ c c c c c } & SYMBOL & & & & & & & & & & & & & & & & & & &$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature. b.  $V_{DD} = 50$  V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5.1 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C.

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RoHS

COMPLIANT

HALOGEN FREE



INGS							
SYMBOL	TYP.		MAX.		UNIT		
R <sub>thJA</sub>	- 62						
R <sub>thJC</sub>	-		0.5			°C/W	
·							
unless otherwi	se noted)						
SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
<b>I</b>	1						1
V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> =	250 µA	600	-	-	V
$\Delta V_{DS}/T_{J}$				-	0.67	-	V/°C
V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> =	250 µA	2	-	4	V
1	$V_{GS} = \pm 20 V$		-	-	± 100	nA	
IGSS		V <sub>GS</sub> = ± 30 V		-	-	± 1	μA
	V <sub>DS</sub> =	= 520 V, V <sub>G</sub>	<sub>is</sub> = 0 V	-	-	1	
IDSS	V <sub>DS</sub> = 520 \			-	-	500	μA
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I	<sub>D</sub> = 11 A	-	0.19	-	Ω
9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> :	= 11 A	-	7.0	-	S
-							
C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2322	-	pF	
C <sub>oss</sub>			-	105	-		
C <sub>rss</sub>			-	4	-		
C <sub>o(er)</sub>	$V_{\rm DS}$ = 0 V to 520 V, $V_{\rm GS}$ = 0 V		-	84	-		
C <sub>o(tr)</sub>			-	293	-		
Qg	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 520 V		-	71	106	nC	
Q <sub>gs</sub>			-	14	-		
Q <sub>gd</sub>			-	33	-		
t <sub>d(on)</sub>		· · · · · · · · · · · · · · · · · · ·		-	22	44	
t <sub>r</sub>				-	34	68	
t <sub>d(off)</sub>	$V_{GS}$ = 10 V, $R_g$ = 9.1 $\Omega$		-	68	102	- ns	
t <sub>f</sub>			-	42	84		
R <sub>g</sub>	f = 1 MHz, open drain		-	0.78	-	Ω	
cs							
I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21	A	
I <sub>SM</sub>			-	-	53		
	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 11 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V	
V <sub>SD</sub>							
	-			-	160	-	ns
V <sub>SD</sub> t <sub>rr</sub> Q <sub>rr</sub>	T <sub>J</sub> = 2	5 °C, Ι <sub>F</sub> = Ι <sub>ξ</sub> 100 Α/μs, '	<sub>S</sub> = 11 A,	-	160 1.2	-	ns µC
	RthJA   RthJC   SYMBOL   VDS   ΔVDs/TJ   VGS(th)   IGSS   IDSS   RDS(on)   9fs   Ciss   Coss   Crss   Co(er)   Co(er)   Qg   Qgd   td(on)   tr   tf   Rg   ics   Is   Is	$\begin{tabular}{ c c c c } \hline SYMBOL & TYP. \\ \hline $R_{th,JA} & - \\ \hline $R_{th,JC} & - \\ \hline $R_{th,JC} & - \\ \hline $SYMBOL & TES \\ \hline $V_{DS} & V_{GS} & \\ \hline $V_{DS} & V_{GS} & \\ \hline $V_{DS}/T_J & Referenc & \\ \hline $V_{DS}/T_J & Referenc & \\ \hline $V_{DS}/T_J & Referenc & \\ \hline $V_{DS} & V_{DS} & \\ \hline $V_{DS} & S^{T} & \\ \hline $V_{DS} & \\ \hline $V_{DS} & S^{T} & \\ \hline $V_{DS} & \\ \hline $V_{DS} & S^{T} & \\ \hline $V_{DS} $	SYMBOLTYP. $R_{thJA}$ - $R_{thJC}$ -unless otherwise noted)SYMBOLTEST CONDIT $V_{DS}$ $V_{GS} = 0 V, I_D =$ $\Delta V_{DS}/T_J$ Reference to 25 °C, $V_{GS}(th)$ $V_{DS} = V_{GS}, I_D =$ $V_{GS}(th)$ $V_{DS} = V_{GS}, I_D =$ $V_{GS}(th)$ $V_{DS} = 520 V, V_G = 10 V$ $I_{DSS}$ $V_{DS} = 520 V, V_{GS} = 0 V$ $I_{DSS}$ $V_{DS} = 10 V$ $I_{SS}$ $V_{GS} = 10 V$ $I_{Coss}$ $V_{DS} = 0 V$ to 520 V, $I_D$ $Q_{g}$ $V_{DS} = 0 V$ to 520 V, $I_D$ $Q_{g}$ $V_{GS} = 10 V$ $I_{D} = 11$ $Q_{gs}$ $I_{d(off)}$ $V_{GS} = 10 V$ $I_{f}$ $V_{DD} = 520 V, I_D$ $V_{GS} = 10 V, R_{g}$ $I_{S}$ MOSFET symbolshowing theintegral reverse $P - n$ junction diode	$\begin{tabular}{ c c c c } \hline SYMBOL & TYP. & MAX. \\ \hline $R_{th,JA}$ & - & 62 \\ \hline $R_{th,JC}$ & - & 0.5 \\ \hline \hline $SYMBOL & TEST CONDITIONS \\ \hline \hline $SYMBOL & TEST CONDITIONS \\ \hline \hline $SYMBOL & TEST CONDITIONS \\ \hline $V_{DS}$ & $V_{GS} = 0 V, I_D = 250 \ \mu A \\ \hline $\Delta V_{DS}/T_J$ & Reference to 25 °C, I_D = 1 mA \\ \hline $V_{GS}(th)$ & $V_{DS} = V_{GS}, I_D = 250 \ \mu A \\ \hline $V_{GS} = \pm 20 \ V$ \\ \hline $I_{GSS}$ & $V_{GS} = \pm 20 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 100 \ V$ \\ \hline $V_{DS} = 100 \ V$ \\ \hline $C_{coss}$ & $V_{DS} = 100 \ V$ \\ \hline $C_{coss}$ & $V_{DS} = 100 \ V$ \\ \hline $C_{coss}$ & $V_{DS} = 100 \ V$ \\ \hline $C_{cotr}$ & $V_{DS} = 0 \ V$ to 520 \ V$ , $V_{GS} = 0 \ V$ \\ \hline $C_{o(tr)$ & $V_{DS} = 0 \ V$ to 520 \ V$ , $V_{GS} = 0 \ V$ \\ \hline $C_{o(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{agd}$ & $V_{CS} = 10 \ V$ \\ \hline $C_{agd}$ & $V_{CS} = 10 \ V$ \\ \hline $C_{p} = 520 \ V$ , $V_{DS} = 520 \ V$ \\ \hline $C_{qgd}$ & $V_{DS} = 10 \ V$ \\ \hline $C_{p} = 520 \ V$ , $V_{p} = 11 \ A$ \\ \hline $V_{DD} = 520 \ V$ , $V_{DS} = 520 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 520 \ V$ , $V_{GS} = 0 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 520 \ V$ , $V_{DS} = 11 \ A$ \\ \hline $V_{DD} = 520 \ V$ , $V_{DS} = 11 \ A$ \\ \hline $V_{DD} = 520 \ V$ , $V_{B} = 11 \ A$ \\ \hline $V_{DS} = 10 \ V$ , $R_{g} = 9.1 \ \Omega$ \\ \hline $T_{t}$ \\ \hline $R_{g}$ & $f = 1 \ MHz$ , $open drain \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a($	$\begin{tabular}{ c c c c c } \hline SYMBOL & TYP. & MAX. \\ \hline $R_{thJA}$ & - & 62 \\ \hline $R_{thJC}$ & - & 0.5 \\ \hline \hline $Unless otherwise noted] \\ \hline $SYMBOL & TEST CONDITIONS & MIN. \\ \hline $V_{DS}$ & $V_{GS} = 0 V, I_D = 250 \ \mu A & 600 \\ \hline $\Delta V_{DS}/T_J$ & Reference to 25 °C, I_D = 1 mA & - \\ \hline $V_{GS}(th)$ & $V_{DS} = V_{GS}, I_D = 250 \ \mu A & 2 \\ \hline $V_{GS} = 10 V$ & $V_{GS} = 250 \ \mu A & 2 \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V & - \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V & - \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V & T_J = 125 \ ^{\circ}C & - \\ \hline $R_{DS}(on)$ & $V_{GS} = 10 \ V$ & $I_D = 11 \ A $- \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V, T_J = 125 \ ^{\circ}C & - \\ \hline $R_{DS}(on)$ & $V_{GS} = 10 \ V$ & $I_D = 11 \ A $- \\ \hline $V_{DS} = 30 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V$ & $I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V$ & $I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V$ & $V_{DS} = 100 \ V$ $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 0 \ V$ to 520 \ V, V_{GS} = 0 \ V$ $- \\ \hline $V_{DS} = 0 \ V$ to 520 \ V, V_{GS} = 0 \ V$ $- \\ \hline $V_{DS} = 10 \ V$ $V_{DS} = 520 \ V$ $- \\ \hline $V_{DS} = 10 \ V$ \ A $- \\ \hline $V_{DS} = 10 \ V$ \ A $- \\ \hline $V_{DS} = 10 \ V$ \ A $- \\ \hline $V_{Co(tr)}$ & $- \\ \hline $V_{DS} = 10 \ V$ \ N_{SS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $A \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = $	$\begin{tabular}{ c c c c c } \hline $YMBOL & TYP. & MAX. \\ \hline $R_{th,JA} & - & 62 \\ \hline $R_{th,JC} & - & 0.5 \\ \hline $Unless otherwise noted] \\ \hline $YMBOL & TEST CONDITIONS & MIN. $TYP. \\ \hline $V_{DS} & V_{GS} = 0 V, I_D = 250 \ \mu A & - & 0.67 \\ \hline $V_{DS}/T_J & Reference to 25 \ ^{\circ}C, I_D = 1 \ m A & - & 0.67 \\ \hline $V_{GS}(th) & V_{DS} = V_{GS}, I_D = 250 \ \mu A & 2 & - \\ \hline $V_{GS}(th) & V_{DS} = 520 \ V, C_{SS} = 420 \ V & - & - \\ \hline $V_{GS} = 520 \ V, V_{GS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{CS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{CS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{CS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{CS} = 0 \ V, T_J = 125 \ ^{\circ}C & - & - \\ \hline $R_{DS}(on) & V_{GS} = 10 \ V & I_D = 11 \ A & - & 0.19 \\ \hline $g_{fs} & V_{DS} = 30 \ V, I_D = 11 \ A & - & 0.19 \\ \hline $g_{fs} & V_{DS} = 100 \ V, f = 1 \ MHz & - & 7.0 \\ \hline \hline $C_{res} & V_{DS} = 10 \ V, OS = 0 \ V \ V_{DS} = 100 \ V, f = 1 \ MHz & - & 4 \\ \hline $C_{o}(er) $V_{CS} = 10 \ V \ V_{DS} = 0 \ V \ V_{DS} = 520 \ V, V_{GS} = 0 \ V \\ \hline $c_{res} & V_{CS} = 10 \ V, R_{g} = 9.1 \ \Omega & - \ $14$ \\ \hline $Q_{gd} & V_{GS} = 10 \ V, R_{g} = 9.1 \ \Omega & - \ $14$ \\ \hline $Q_{Qg} & V_{GS} = 10 \ V, R_{g} = 9.1 \ \Omega & - \ $14$ \\ \hline $C_{o}(er) $V_{DD} = 520 \ V, I_D = 11 \ A, V_{DS} = 520 \ V & - \ $14$ \\ \hline $Q_{Qg} & V_{GS} = 10 \ V, R_{g} = 9.1 \ \Omega & - \ $14$ \\ \hline $Q_{2} \ R_{g} & f = 1 \ MHz, \ $open \ drain \ $-$ \ $0.78$ \\ \hline $c$ \\ \hline \hline $I_{SM} & MOSFET \ symbol $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $p - $n$ junction diode $showing the $integral reverse $$	$\begin{tabular}{ c c c c c c } \hline SYMBOL & TYP. & MAX. & UNIT \\ \hline $R_{th,JC} & - & 0.5 & \end{tabular} tabul$

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

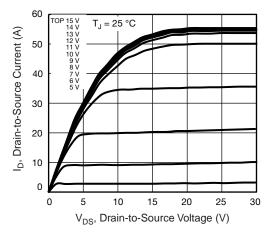


Fig. 1 - Typical Output Characteristics



Fig. 2 - Typical Output Characteristics

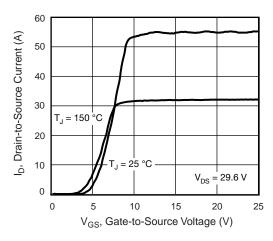


Fig. 3 - Typical Transfer Characteristics

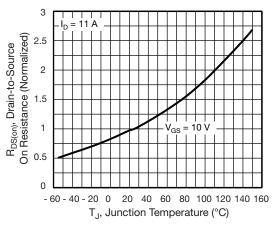


Fig. 4 - Normalized On-Resistance vs. Temperature

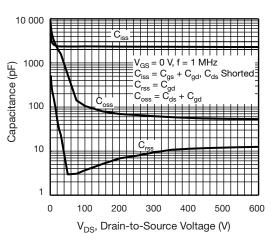


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

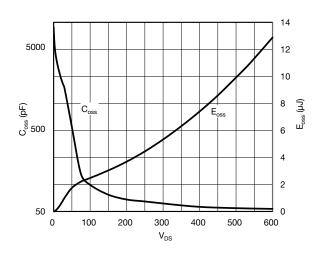


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 



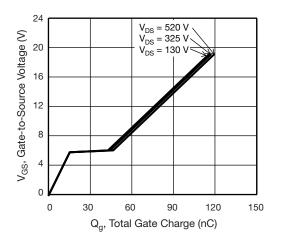


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

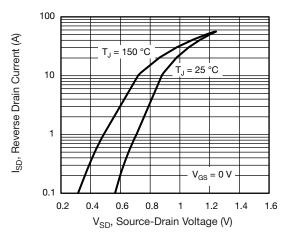


Fig. 8 - Typical Source-Drain Diode Forward Voltage

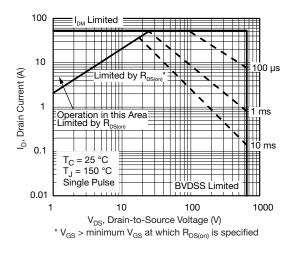


Fig. 9 - Maximum Safe Operating Area

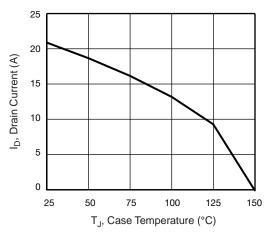


Fig. 10 - Maximum Drain Current vs. Case Temperature



Fig. 11 - Temperature vs. Drain-to-Source Voltage



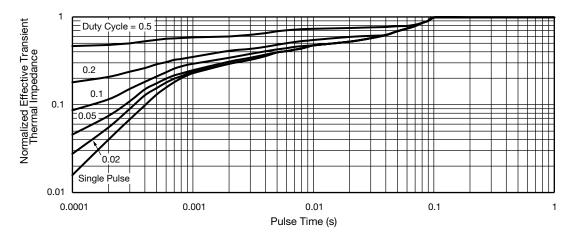


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case



Fig. 13 - Switching Time Test Circuit



Fig. 14 - Switching Time Waveforms

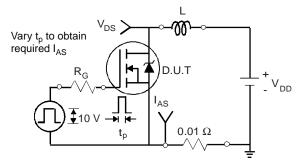


Fig. 15 - Unclamped Inductive Test Circuit

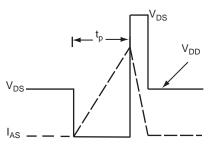


Fig. 16 - Unclamped Inductive Waveforms

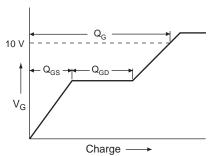
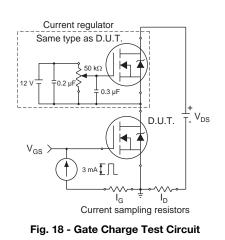
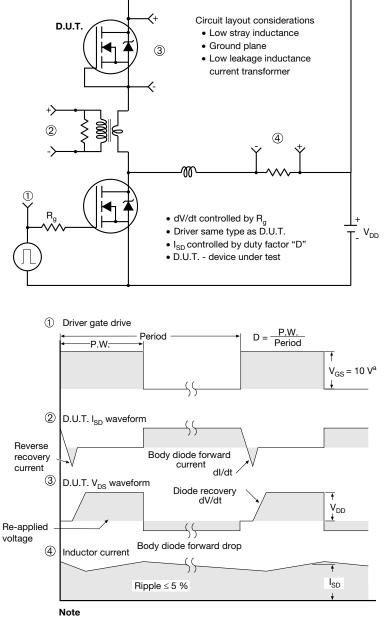


Fig. 17 - Basic Gate Charge Waveform





## Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel



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